

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

P-CHANNEL SIGNAL MOS FET FOR SWITCHING

The 2SJ411 is a P-channel MOS FET of a vertical type and is a switching element that can be directly driven by the output of an IC operating at 5 V.

This product has a low ON resistance and superb switching characteristics and is ideal for power control switches and DC/DC converters.

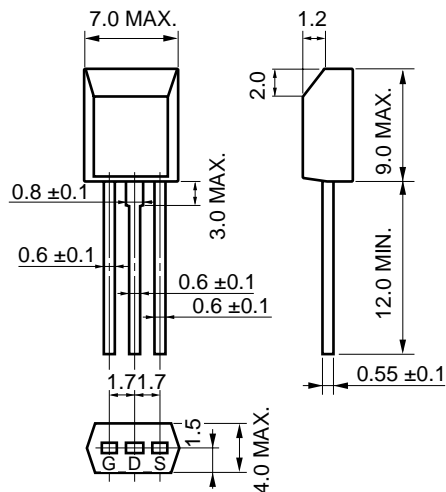
FEATURES

- Radial tapering supported
- Can be directly driven by 5-V IC
- Low ON resistance

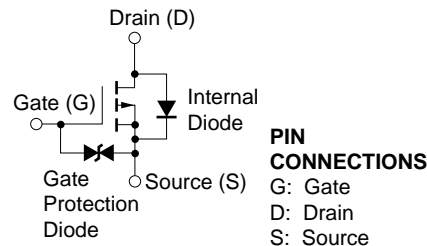
$R_{DS(on)} = 0.24 \Omega$ MAX. @ $V_{GS} = -4 V, I_D = -2.5 A$

$R_{DS(on)} = 0.11 \Omega$ MAX. @ $V_{GS} = -10 V, I_D = -2.5 A$

PACKAGE DIMENSIONS (in mm)



EQUIVALENT CIRCUIT



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C)

PARAMETER	SYMBOL	TEST CONDITIONS	RATING	UNIT
Drain to Source Voltage	V _{DSS}	V _{GS} = 0	-30	V
Gate to Source Voltage	V _{GSS}	V _{DS} = 0	-20/+10	V
Drain Current (DC)	I _{D(DC)}		±5.0	A
Drain Current (Pulse)	I _{D(pulse)}	PW ≤ 10 μs Duty cycle ≤ 1 %	±20.0	A
Total Power Dissipation	P _{T1}	T _A = 25 °C	1.0	W
Total Power Dissipation	P _{T2}	T _C = 25 °C	6.0	W
Channel Temperature	T _{ch}		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

The internal diode connected between the gate and source of this product is to protect the product from static electricity. If the product is used in a circuit where the rated voltage of the product may be exceeded, connect a protection circuit.

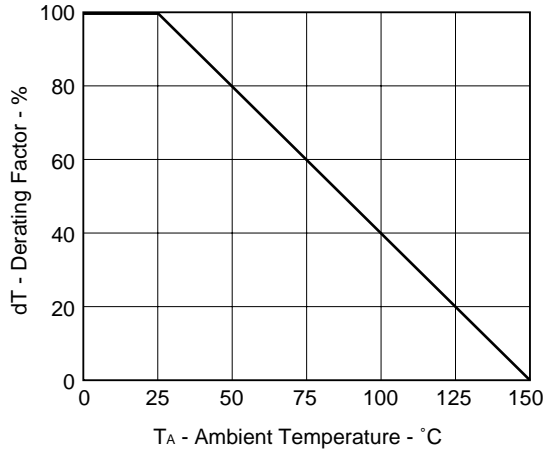
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ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

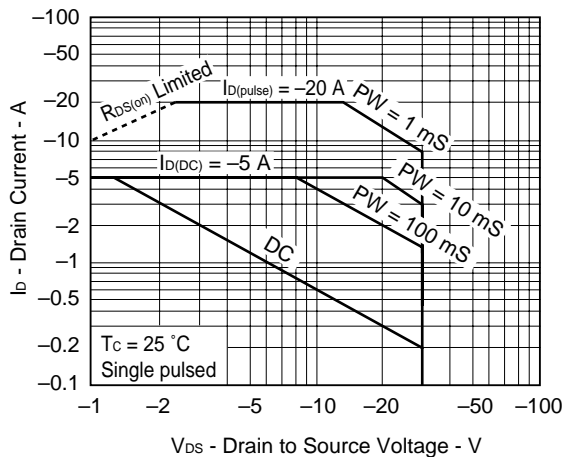
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-Off Current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0			-10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = -16/+10 V, V _{DS} = 0			±10	μA
Gate Cut-Off Voltage	V _{GS(off)}	V _{DS} = -10 V, I _D = -1 mA	-1.0	-1.4	-2.0	V
Forward Transfer Admittance	y _{fs}	V _{DS} = -10 V, I _D = -2.5 A	3.0			S
Drain to Source On-State Resistance	R _{DS(on)1}	V _{GS} = -4 V, I _D = -2.5 A		0.175	0.24	Ω
Drain to Source On-State Resistance	R _{DS(on)2}	V _{GS} = -10 V, I _D = -2.5 A		0.096	0.11	Ω
Input Capacitance	C _{iss}	V _{DS} = -10 V, V _{GS} = 0		790		pF
Output Capacitance	C _{oss}	f = 1.0 MHz		580		pF
Reverse Transfer Capacitance	C _{rss}			280		pF
Turn-On Delay Time	t _{d(on)}	V _{DD} = -15 V, I _D = -2.5 A		10		ns
Rise Time	t _r	V _{GS(on)} = -10 V		110		ns
Turn-Off Delay Time	t _{d(off)}	R _G = 10 Ω, R _L = 6 Ω		195		ns
Fall Time	t _f			185		ns
Gate Input Charge	Q _G	V _{DS} = -24 V		29.8		nC
Gate to Source Charge	Q _{GS}	V _{GS} = -10 V		2.7		nC
Gate to Drain Charge	Q _{GD}	I _D = -5.0 A, I _G = -2 mA		11.5		nC
Internal Diode Forward Voltage	V _{F(S-D)}	I _F = 5.0 A, V _{GS} = 0		1.0		V
Internal Diode Reverse Recovery Time	t _{rr}	I _F = 5.0 A, V _{GS} = 0		140		ns
Internal Diode Reverse Recovery Charge	Q _{rr}	di/dt = 50 A/μs		160		nC

TYPICAL CHARACTERISTICS (T_A = 25 °C)

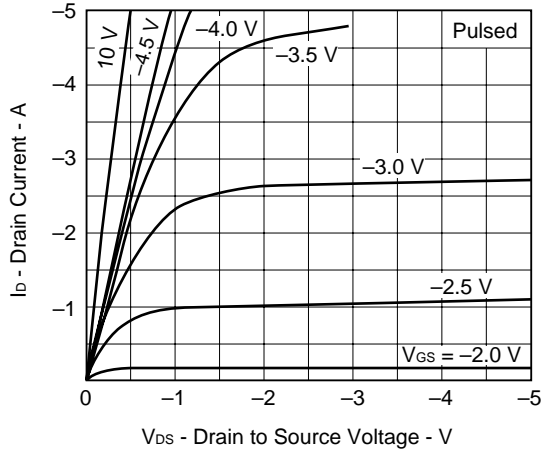
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



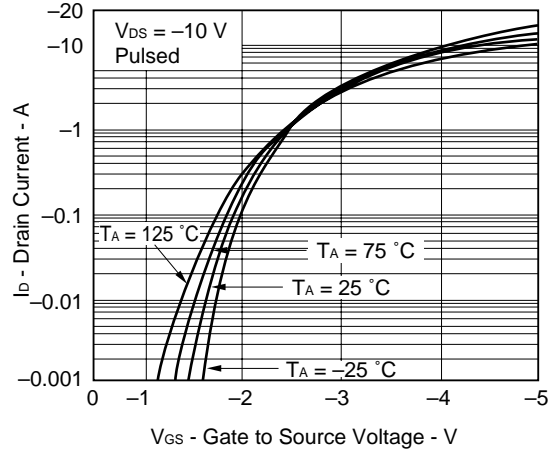
FORWARD BIAS SAFE OPERATING AREA



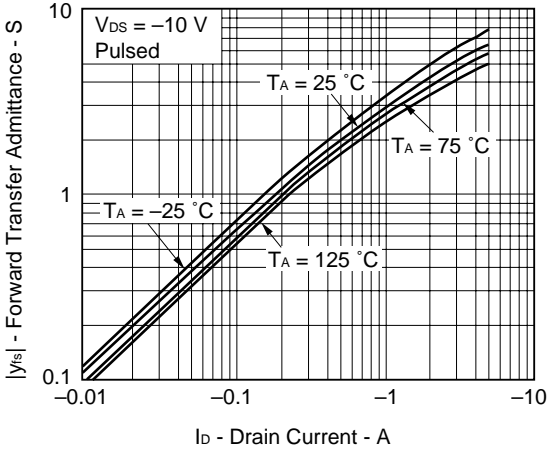
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



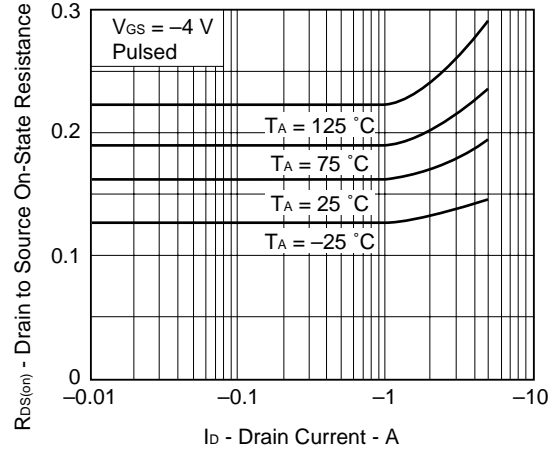
TRANSFER CHARACTERISTICS



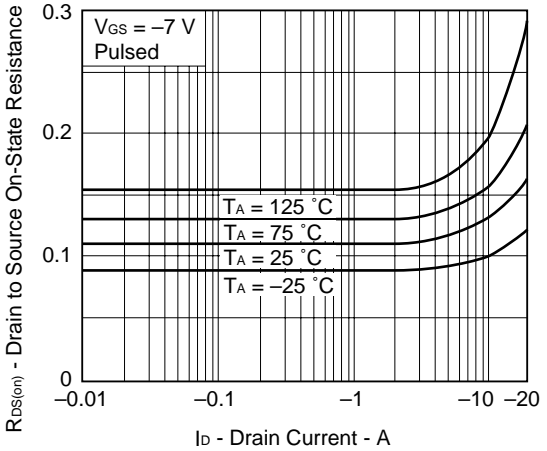
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



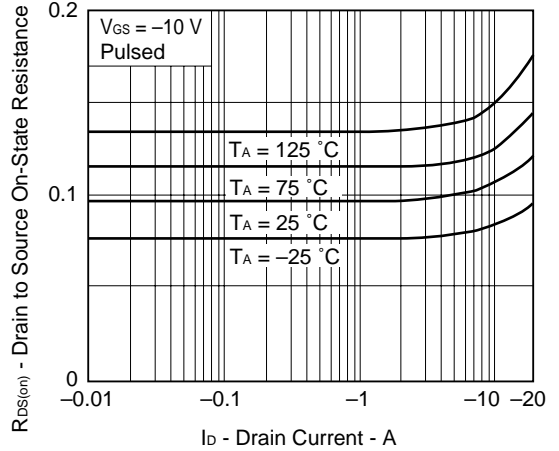
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



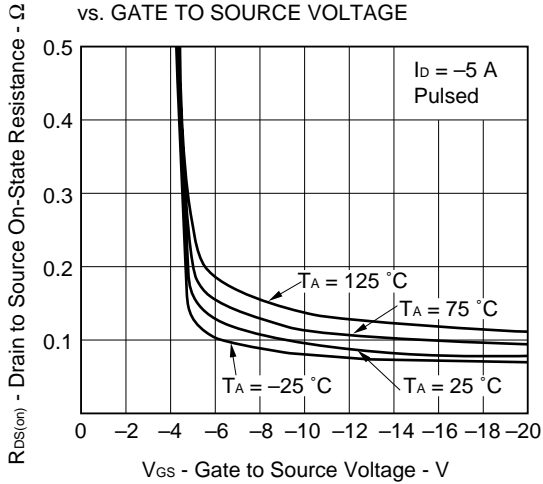
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



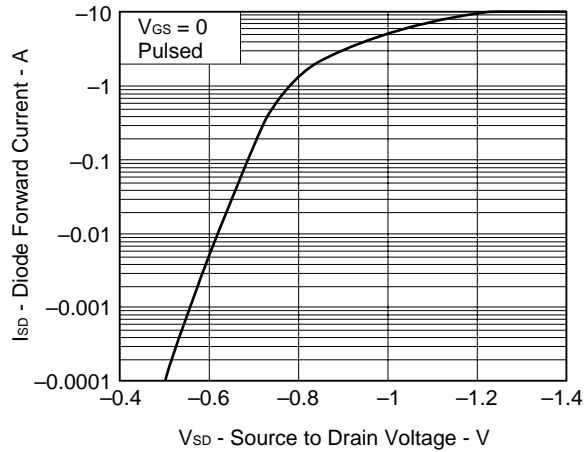
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



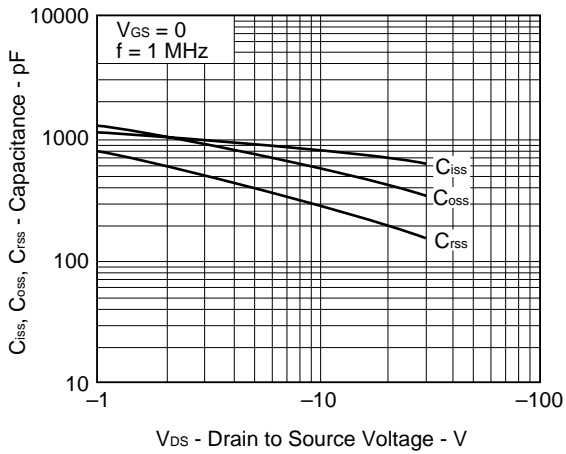
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



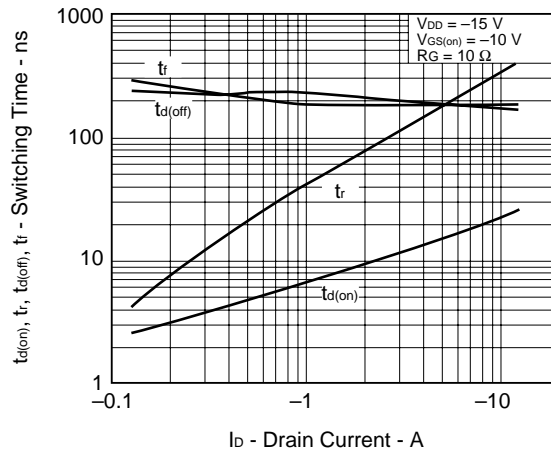
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



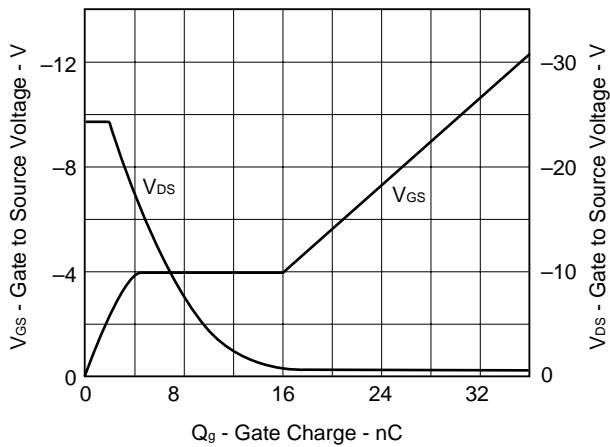
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

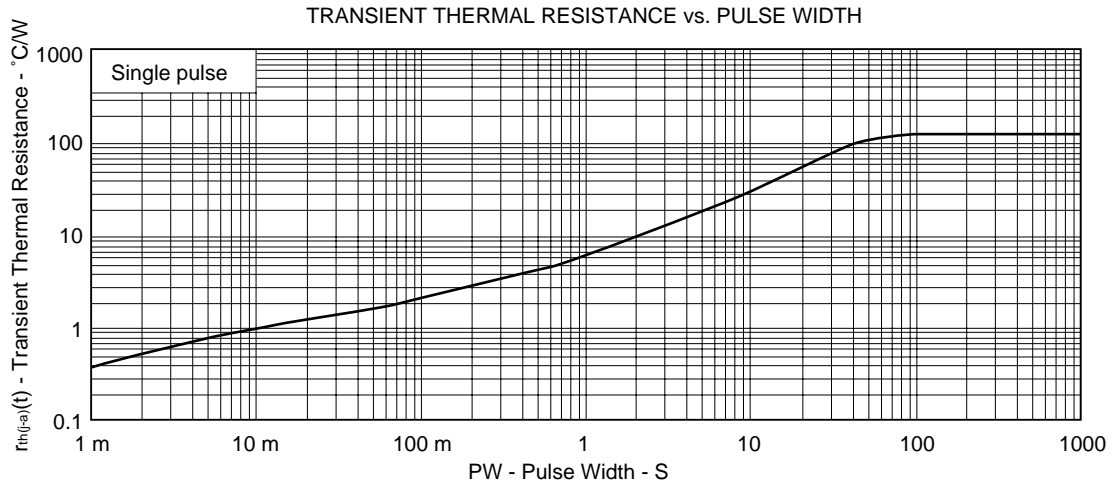


SWITCHING CHARACTERISTICS



DYNAMIC INPUT/OUTPUT CHARACTERISTICS





REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system	TEI-1202
Quality grade on NEC semiconductor devices	IEI-1209
Semiconductor device mounting technology manual	C10535E
Guide to quality assurance for semiconductor devices	MEI-1202
Semiconductor selection guide	X10679E

[MEMO]

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Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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Anti-radioactive design is not implemented in this product.